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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/784,769	02/24/2004	Koichiro Kishima	SON-2324/DIV1	8332
23353 7	590 09/21/2004		EXAM	INER
	IMAN & GRAUER I	CHOI, WILLIAM C		
LION BUILDI 1233 20TH ST	NG REET N.W., SUITE 50	1	ART UNIT	PAPER NUMBER
	N, DC 20036	· -	2873	<u> </u>

DATE MAILED: 09/21/2004

Please find below and/or attached an Office communication concerning this application or proceeding.

		Application No.	Applicant(s)				
Office Action Summary							
		10/784,769	KISHIMA ET AL.				
		Examiner	Art Unit				
	The MAILING DATE of this communication app	William C. Choi	2873				
Period fo	or Reply	ears on the cover sheet with the	o correspondence address				
THE - Exte after - If the - If NC - Failt Any	ORTENED STATUTORY PERIOD FOR REPLY MAILING DATE OF THIS COMMUNICATION. nsions of time may be available under the provisions of 37 CFR 1.13 SIX (6) MONTHS from the mailing date of this communication. e period for reply specified above is less than thirty (30) days, a reply period for reply is specified above, the maximum statutory period we use to reply within the set or extended period for reply will, by statute, reply received by the Office later than three months after the mailing ed patent term adjustment. See 37 CFR 1.704(b).	36(a). In no event, however, may a reply be within the statutory minimum of thirty (30) d iill apply and will expire SIX (6) MONTHS fro cause the application to become ABANDO	timely filed lays will be considered timely. om the mailing date of this communication. NED (35 U.S.C. & 133).				
Status							
1) 🏻	Responsive to communication(s) filed on 24 Fe	ebruary 2004					
	This action is FINAL . 2b) This action is non-final.						
3)□	_						
Disposit	ion of Claims						
_							
7)[✓ Claim(s) <u>9-16</u> is/are pending in the application. 4a) Of the above claim(s) is/are withdrawn from consideration. 						
5)□	Claim(s) is/are allowed. Claim(s) 9-16 is/are rejected. Claim(s) is/are objected to.						
· —							
7)							
/							
Applicat	ion Papers						
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	The specification is objected to by the Examiner		tod to butbo Fugurinas				
10)[10) ☐ The drawing(s) filed on 24 February 2004 is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.						
	Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).						
11)	Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d). 11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.						
		ammer. Note the attached Offic	ce Action of form F10-132.				
Priority (under 35 U.S.C. § 119						
 12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some * c) None of: 1. Certified copies of the priority documents have been received. 							
	2. \boxtimes Certified copies of the priority documents have been received in Application No. 10/052,252.						
	3. Copies of the certified copies of the priority documents have been received in this National Stage						
	application from the International Bureau (PCT Rule 17.2(a)).						
* See the attached detailed Office action for a list of the certified copies not received.							
Attachment(s)							
	e of References Cited (PTO-892) te of Draftsperson's Patent Drawing Review (PTO-948)	4) La Interview Summa Paper No(s)/Mail					
3) 🔲 Infor	mation Disclosure Statement(s) (PTO-1449 or PTO/SB/08) or No(s)/Mail Date		Patent Application (PTO-152)				

DETAILED ACTION

Priority

Acknowledgment is made of applicant's claim for foreign priority under 35 U.S.C. 119(a)-(d). The certified copy has been filed in parent Application No. 10/052,252, filed on January 23, 2002.

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

Claims 9-16 are rejected under 35 U.S.C. 102(b) as being anticipated by Eda et al (U.S. 5,728,509).

In regard to claims 9 and 16, Eda et al discloses a method of producing an optical lens (column 4, lines 31-41) / array (column 7, lines 57-62), comprising the steps of: forming, on a substrate made of an optical material (column 18, lines 1-2, Figure 4a, "40"), a mask layer corresponding to a shape of an optical lens having a pattern whose width in a first direction is different from a width thereof in a second direction perpendicular to the first direction (column 18, lines 2-6 and lines 52-59, Figure 4a, "42"); deforming the mask layer by heat treatment so that a surface area of the mask layer may be reduced (column 18, lines 17-29, Figure 4c, "42" and 4d, "42a"); and

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removing the mask layer and the substrate simultaneously to transfer the shape of the mask layer to the substrate to form the shape of the optical lens (column 18, lines 39-46, Figure 4e, "12").

Regarding claim 10, Eda et al discloses wherein the mask layer is formed by performing a light-exposure and development process for a photosensitive material film to pattern the photosensitive material film (column 18, lines 2-16).

Regarding claim 11, Eda et al discloses wherein, in the step of deforming the mask layer by heat treatment so that a surface area of the mask layer may be reduced, the heat treatment is performed at a temperature higher than a glass transition point of the photosensitive material film (column 18, lines 17-20).

Regarding claim 12, Eda et al discloses wherein, in the step of deforming the mask layer by heat treatment so that a surface area of the mask layer may be reduced, the heat treatment is performed at a temperature lower than a carbonization temperature of the photosensitive material film (column 18, lines 17-20).

Regarding claim 13, Eda et al discloses wherein, in the step of deforming the mask layer by heat treatment so that a surface area of the mask layer may be reduced, the heat treatment is performed at a temperature higher than a room temperature (column 18, lines 17-18).

Regarding claim 14, Eda et al discloses wherein, in the step of removing the mask layer and the substrate simultaneously, a dry etching process is performed using the mask layer as a mask to transfer the shape of the mask layer to the substrate to form the shape of the optical lens (column 18, lines 39-46).

Regarding claim 15, the dry etching process of Eda et al would inherently be performed in a condition that selection ratios for the substrate and the mask layer are substantially equal to each other, this being reasonably assumed from the complete shape transferal shown in Figure 4e.

Conclusion

The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. Robello et al (U.S. 5,723,264), Nakai (U.S. 5,396,090), Basavanhally (U.S. 5,346,583) and Tsumori (U.S. 5,324,623) are being cited herein to show methods of producing optical lenses, which comprise the steps of the claimed invention. However, addition rejections would have been repetitive.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to William C. Choi whose telephone number is (571) 272-2324. The examiner can normally be reached on Monday-Friday from about 9:00 am to 6 pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Georgia Y. Epps can be reached on (571) 272-2328. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR.

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Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

William Choi Patent Examiner Art Unit 2873 September 14, 2004

Georgia Epps

Supervisory Patent Examiner Technology Center 2800